PCN Number:			20140204002					PCN Date:		02/05/2014	
Title:		LM97937 datasheet									
Cu	stom	er Contact:	PCI	N Ma	nager	Phone:	+1(214) 480-6037		Dept:	Qua	ality Services
Change Type:											
Assembly Site				Assembly Process				Assembly Materials			
Design			\boxtimes	Electrical Specification				Mechanical Specification			
Test Site				Packing/Shipping/Labeling				Test Process			
Wafer Bump Site					Wafer Bump Material				Wafer Bump Process		
Wafer Fab Site					Wafer Fab Materials				Wafer Fab Process		
					Part number change						
PCN Details											
B 111 COL											

Description of Change:

The product datasheet(s) is being update to add DC_EN to the register descriptions:

- Fix CHIP_ID value in register map
- Fix pin descriptions to indicate SPI logic compatibility with 1.2V-3.3V (not 1.2-1.8V)
- Include mention of VD1.2 in total power consumption description
- Fix pin interface diagram for SYNCb input.

The following change history provides further details. These changes may be reviewed at the datasheet links provided

LM97937



SNVS990A - DECEMBER 2013-REVISED JANUARY 2014

www.ti.com

REVISION HISTORY

The datasheet number will be changing.

Device Family	Change From:	Change To:
LM97937	SNVS990	SNVS990A

The updated datasheet(s) can be accessed by the following link(s): http://www.ti.com/product/lm97937

Reason for Change:					
To more accurately reflect device characteristics.					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
Electrical specification performance changes as indicated above.					
Changes to product identification resulting from this PCN:					
None					
Product Affected:					
LM97937RMER	LM97937RMET]			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com